STF8NK85Z N-CHANNEL 850V -1.1Ω - 6.7A TO-220/TO-220FP Zener-Protected SuperMESH™MOSFET

Table 1: General Features

TYPE	V _{DSS}	R _{DS(on)}	ID	Pw
STP8NK85Z	850 V	<1.4 Ω	6.7A	150 W
STF8NK85Z	850 V	<1.4 Ω	6.7A	35 W

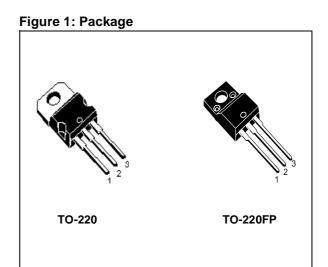
- TYPICAL $R_{DS}(on) = 1.1\Omega$
- EXTREMELY HIGH dv/dt CAPABILITY
- IMPROVED ESD CAPABILITY
- 100% AVALANCHE RATED
- GATE CHARGE MINIMIZED
- VERY LOW INTRINSIC CAPACITANCES
- VERY GOOD MANUFACTURING REPEATIBILITY

DESCRIPTION

The SuperMESH[™] series is obtained through an extreme optimization of ST's well established strip-based PowerMESH[™] layout. In addition to pushing on-resistance significantly down, special care is taken to ensure a very good dv/dt capability for the most demanding applications. Such series complements ST full range of high voltage MOS-FETs including revolutionary MDmesh[™] products.

APPLICATIONS

- HIGH CURRENT, HIGH SPEED SWITCHING
- IDEAL FOR OFF-LINE POWER SUPPLIES
- SMPS



STP8NK85Z

Figure 2: Internal Schematic Diagram

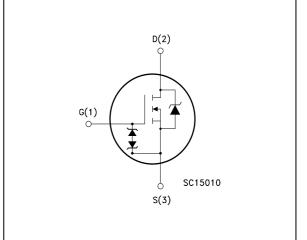


Table 2: Order Codes

SALES TYPE	MARKING	PACKAGE	PACKAGING
STP8NK85Z	P8NK85Z	TO-220	TUBE
STF8NK85Z	F8NK85Z	TO-220FP	TUBE

STP8NK85Z - STF8NK85Z

Symbol	Parameter	Val	Unit	
		TO-220	TO-220FP	
V _{DS}	Drain-source Voltage (V _{GS} = 0)	85	0	V
V _{DGR}	Drain-gate Voltage ($R_{GS} = 20 \text{ k}\Omega$)	85	0	V
V_{GS}	Gate- source Voltage	±3	30	V
Ι _D	Drain Current (continuous) at $T_C = 25^{\circ}C$	6.7	6.7 (*)	А
I _D	Drain Current (continuous) at T _C = 100°C	4.3	4.3 (*)	А
I _{DM} (•)	Drain Current (pulsed)	26.7	26.7 (*)	А
P _{TOT}	Total Dissipation at $T_C = 25^{\circ}C$	150	35	W
	Derating Factor	1.20	0.28	W/°C
V _{ESD(G-S)}	Gate source ESD(HBM-C=100pF, R=1.5KΩ)	400	00	KV
dv/dt (1)	Peak Diode Recovery voltage slope	4.5		V/ns
VISO	Insulation Withstand Voltage (DC) - 2500		2500	V
T _j T _{stg}	Operating Junction Temperature Storage Temperature	-55 to 150 -55 to 150		℃ ℃

Table 3: Absolute Maximum ratings

(•) Pulse width limited by safe operating area

(1) I_{SD} ≤6.7A, di/dt ≤200A/µs, V_{DD} = 80% V_{(BR)DSS}

(*) Limited only by maximum temperature allowed

Table 4: Thermal Data

		TO-220	TO-220FP	
Rthj-case	Thermal Resistance Junction-case Max	0.83	3.6	°C/W
Rthj-amb	Thermal Resistance Junction-ambient Max	62.5		°C/W
Τı	Maximum Lead Temperature For Soldering Purpose	300		°C

Table 5: Avalanche Characteristics

Symbol	Parameter	Max Value	Unit
I _{AR}	Avalanche Current, Repetitive or Not-Repetitive (pulse width limited by T_j max)	6.7	A
E _{AS}	Single Pulse Avalanche Energy (starting $T_j = 25 \text{ °C}$, $I_D = I_{AR}$, $V_{DD} = 50 \text{ V}$)	350	mJ

Table 6: Gate-Source Zener Diode

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
BV _{GSO}	Gate-Source Breakdown Voltage	Igs=± 1mA (Open Drain)	30			V

PROTECTION FEATURES OF GATE-TO-SOURCE ZENER DIODES

The built-in back-to-back Zener diodes have specifically been designed to enhance not only the device's ESD capability, but also to make them safely absorb possible voltage transients that may occasionally be applied from gate to source. In this respect the Zener voltage is appropriate to achieve an efficient and cost-effective intervention to protect the device's integrity. These integrated Zener diodes thus avoid the usage of external components.

ELECTRICAL CHARACTERISTICS (T_{CASE} =25°C UNLESS OTHERWISE SPECIFIED) Table 7: On/Off

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source Breakdown Voltage	I _D = 1 mA, V _{GS} = 0	850			V
IDSS	Zero Gate Voltage Drain Current (V _{GS} = 0)	V_{DS} = Max Rating V_{DS} = Max Rating, T _C = 125 °C			1 50	μA μA
I _{GSS}	Gate-body Leakage Current (V _{DS} = 0)	$V_{GS} = \pm 20V$			±10	μA
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 100 \mu A$	3	3.75	4.5	V
R _{DS(on)}	Static Drain-source On Resistance	V _{GS} = 10V, I _D = 3.35 A		1.1	1.4	Ω

Table 8: DYNAMIC

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
g _{fs} (1)	Forward Transconductance	V _{DS} = 15 V _, I _D = 3.35 A		6		S
C _{iss} C _{oss} C _{rss}	Input Capacitance Output Capacitance Reverse Transfer Capacitance	V _{DS} = 25V, f = 1 MHz, V _{GS} = 0		1870 190 44		pF pF pF
C _{oss eq.} (3)	Equivalent Output Capacitance	$V_{GS} = 0V$, $V_{DS} = 0V$ to 680V		75		pF
$\begin{matrix}t_{d(on)}\\t_{r}\\t_{d(off)}\\t_{f}\end{matrix}$	Turn-on Delay Time Rise Time Turn-off Delay Time Fall Time	$V_{DD} = 425 \text{ V}, I_D = 3.35 \text{ A}$ $R_G = 4.7\Omega \text{ V}_{GS} = 10 \text{ V}$ (see Figure 19)		26 19 58 18		ns ns ns ns
t _{r(Voff)} t _f t _c	Off-voltage Rise Time Fall Time Cross-over Time	$V_{DD} = 680 \text{ V}, I_D = 6.7 \text{ A}, R_G = 4.7\Omega, V_{GS} = 10V$ (see Figure 20)		12 10 24		ns ns ns
Q _g Q _{gs} Q _{gd}	Total Gate Charge Gate-Source Charge Gate-Drain Charge	$\label{eq:VD} \begin{array}{l} V_{DD} = 680 \text{V}, \ \text{I}_{D} = 6.7 \ \text{A}, \\ V_{GS} = 10 \text{V} \\ \text{(see Figure 22)} \end{array}$		60 12 35	84	nC nC nC

Table 9: Source Drain Diode

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
I _{SD} I _{SDM} (2)	Source-drain Current Source-drain Current (pulsed)				6.7 26.7	A A
V _{SD} (1)	Forward On Voltage	$I_{SD} = 6.7 \text{ A}, V_{GS} = 0$			1.6	V
t _{rr} Q _{rr} I _{RRM}	Reverse Recovery Time Reverse Recovery Charge Reverse Recovery Current	$I_{SD} = 6.7 \text{ A}, \text{ di/dt} = 100\text{A/}\mu\text{s}$ $V_{DD} = 35\text{V}, \text{T}_{j} = 25^{\circ}\text{C}$ (see Figure 20)		530 4.5 17		ns μC Α
t _{rr} Q _{rr} I _{RRM}	Reverse Recovery Time Reverse Recovery Charge Reverse Recovery Current	$V_{DD} = 35V, T_j = 150^{\circ}C$ 6		690 6.4 17		ns μC Α

Note: 1. Pulsed: Pulse duration = 300 μs, duty cycle 1.5 %.
2. Pulse width limited by safe operating area.

^{3.} Coss eq. is defined as a constant equivalent capacitance giving the same charging time as C_{oss} when V_{DS} increases from 0 to 80% V_{DSS} .

Figure 3: Safe Operating Area for TO-220

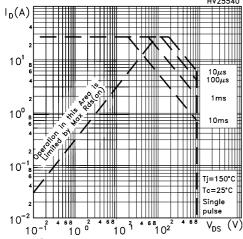
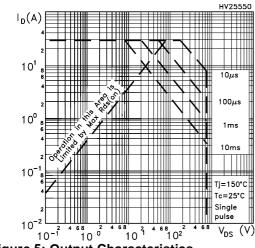


Figure 4: Safe Operating Area for TO-220FP





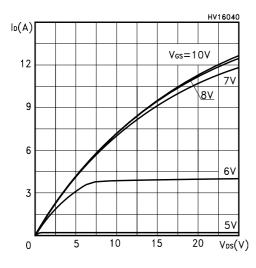


Figure 6: Thermal Impedance for TO-220

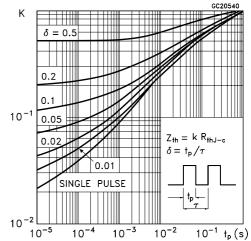
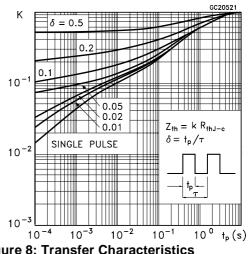


Figure 7: Thermal Impedance for TO-220FP





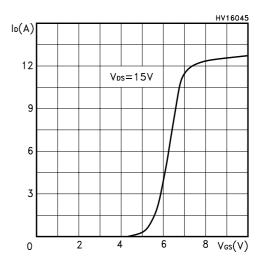


Figure 9: Transconductance

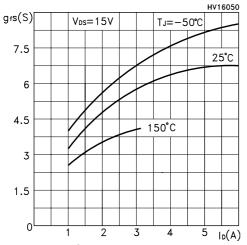


Figure 10: Gate Charge vs Gate-source Voltage

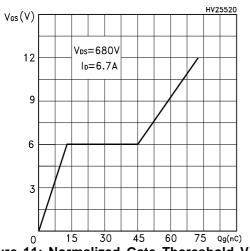


Figure 11: Normalized Gate Thereshold Voltage vs Temperature

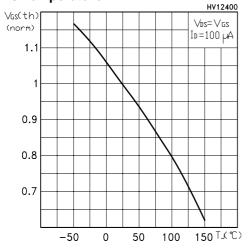


Figure 12: Static Drain-source On Resistance

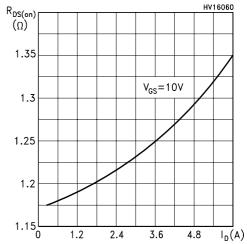
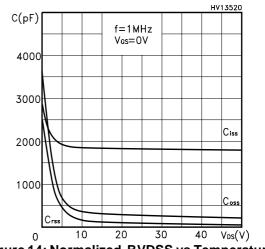


Figure 13: Capacitance Variations





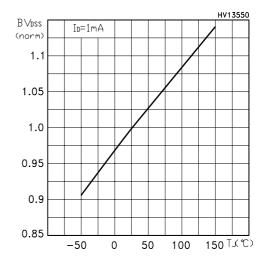


Figure 15: Normalized On Resistance vs TemperatureS

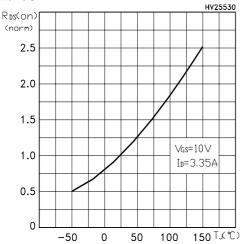
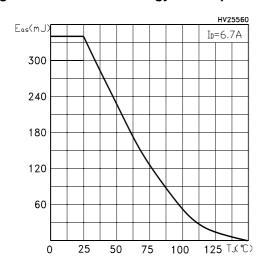
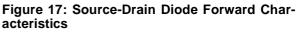


Figure 16: Avalanche Energy vs Temperature





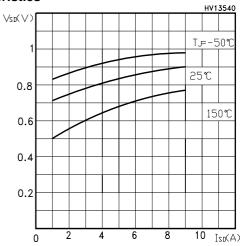


Figure 18: Unclamped Inductive Load Test Circuit

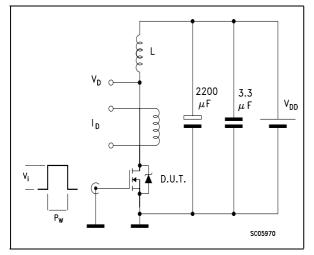


Figure 19: Switching Times Test Circuit For Resistive Load

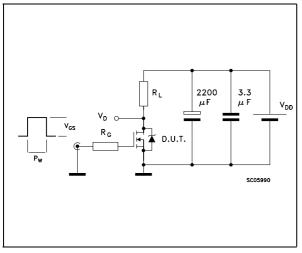


Figure 20: Test Circuit For Inductive Load Switching and Diode Recovery Times

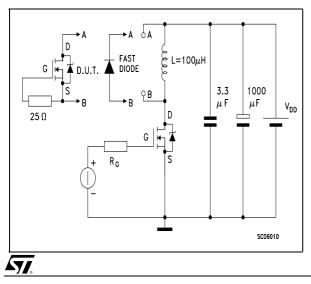


Figure 21: Unclamped Inductive Wafeform

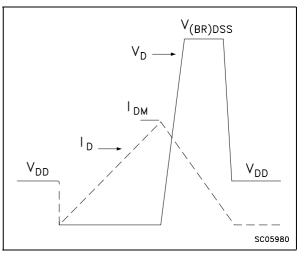
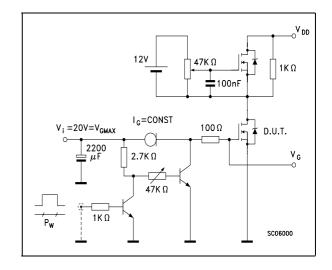


Figure 22: Gate Charge Test Circuit



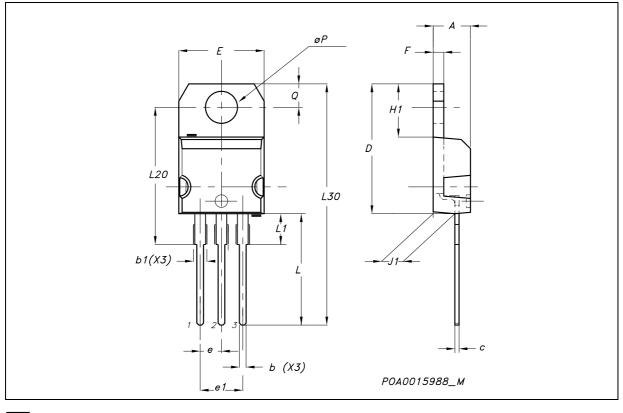
STP8NK85Z - STF8NK85Z

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect . The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com



DIM		mm.			inch	
DIM.	MIN.	ТҮР	MAX.	MIN.	TYP.	MAX.
А	4.40		4.60	0.173		0.181
b	0.61		0.88	0.024		0.034
b1	1.15		1.70	0.045		0.066
С	0.49		0.70	0.019		0.027
D	15.25		15.75	0.60		0.620
E	10		10.40	0.393		0.409
е	2.40		2.70	0.094		0.106
e1	4.95		5.15	0.194		0.202
F	1.23		1.32	0.048		0.052
H1	6.20		6.60	0.244		0.256
J1	2.40		2.72	0.094		0.107
L	13		14	0.511		0.551
L1	3.50		3.93	0.137		0.154
L20		16.40			0.645	
L30		28.90			1.137	
øP	3.75		3.85	0.147		0.151
Q	2.65		2.95	0.104		0.116

TO-220 MECHANICAL DATA



STP8NK85Z - STF8NK85Z

DIM.		mm.			inch	
DIW.	MIN.	ТҮР	MAX.	MIN.	TYP.	MAX.
А	4.4		4.6	0.173		0.181
В	2.5		2.7	0.098		0.106
D	2.5		2.75	0.098		0.108
Е	0.45		0.7	0.017		0.027
F	0.75		1	0.030		0.039
F1	1.15		1.7	0.045		0.067
F2	1.15		1.7	0.045		0.067
G	4.95		5.2	0.195		0.204
G1	2.4		2.7	0.094		0.106
Н	10		10.4	0.393		0.409
L2		16			0.630	
L3	28.6		30.6	1.126		1.204
L4	9.8		10.6	.0385		0.417
L5	2.9		3.6	0.114		0.141
L6	15.9		16.4	0.626		0.645
L7	9		9.3	0.354		0.366
Ø	3		3.2	0.118		0.126

TO-220FP MECHANICAL DATA

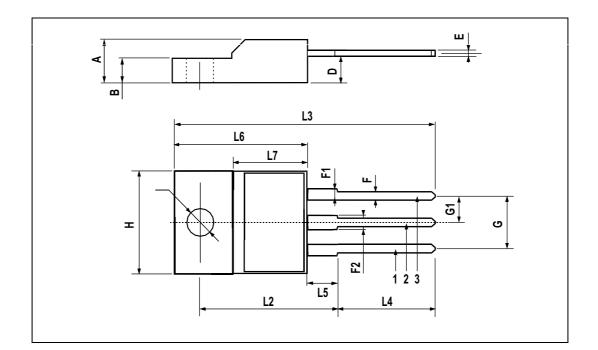


Table 10: Revision History

Date	Revision	Description of Changes
02-Mar-2005	1	First Release.
03-Mar-2005	2	Modified value in table 7
26-Apr-2005	3	Modified values in table 8 and inserted curves. Final datasheet.
09-May-2005	4	Modified note1 and Application Scope
06-Sep-2005	5	Inserted Ecopack indication



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